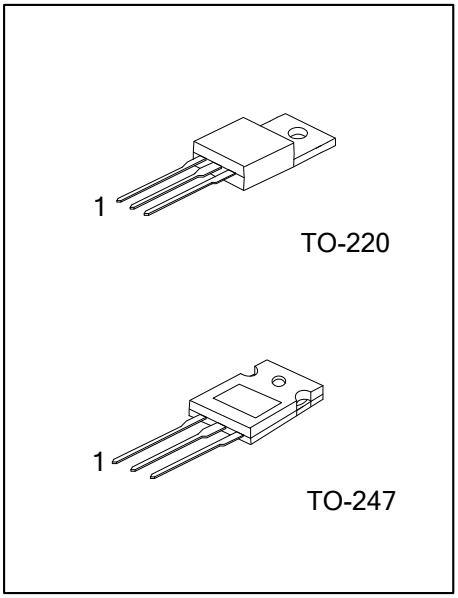
UTG70N65-S

Insulated Gate Bipolar Transistor

650V TRENCH GATE FIELD-STOP IGBT



■ DESCRIPTION

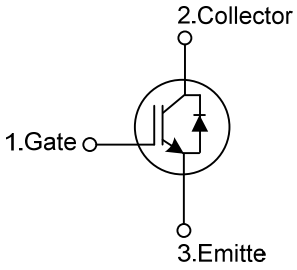
The UTC **UTG70N65-S** is an Trench Field-Stop Insulated Gate Bipolar Transistor. it uses UTC's advanced technology to provide customers with high switching speed, low saturation voltage and low switching loss, etc.

The UTC **UTG70N65-S** is suitable for the resonant or soft switching applications.

■ FEATURES

* High switching speed
* High avalanche ruggedness
* Low saturation voltage: $V_{CE(SAT).Typ.}$=1.75V @ I_C=70A, V_{GE}=15V (T_C =25°C)

■ SYMBOL



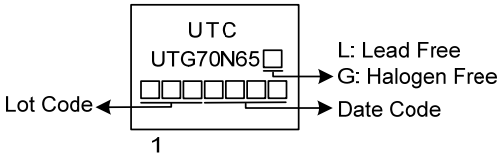
■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
UTG70N65L-TA3-T	UTG70N65G-TA3-T	TO-220	G	C	E	Tube
UTG70N65L-T47-T	UTG70N65G-T47-T	TO-247	G	C	E	Tube

Note: Pin Assignment: G: Gate C: Collector E: Emitter

UTG70N65G-TA3-T (1)Packing Type (2)Package Type (3)Green Package	(1) T: Tube (2) TA3: TO-220, T47: TO-247 (3) G: Halogen Free and Lead Free, L: Lead Free

■ MARKING



■ ABSOLUTE MAXIMUM RATINGS (T_A=25°C, unless otherwise noted)

PARAMETER		SYMBOL	RATINGS	UNIT
Collector-Emitter Voltage		V_{CES}	650	V
Gate-Emitter Voltage		V_{GES}	±20	V
Transient Gate-emitter voltage (t_p < 5 ms)			±25	V
Continuous Collector Current	T_C=25°C	I_C	140	A
	T_C=100°C		70	A
Collector Current Pulsed (Note 1)		I_{CM}	280	A
Diode Forward Current	T_C=25°C	I_F	140	A
	T_C=100°C		70	A
Short Circuit Withstand Time V_{GE} = 15V, V_{CC} ≤ 200V Allowed number of short circuits < 1000 Time between short circuits: ≥1.0s T_{VJ}= 25°C		t_{SC}	3	μs
Power Dissipation (T_C=25°C)	TO-220	P_D	125	W
	TO-247		310	W
Operating Junction Temperature		T_J	-40 ~ +175	°C
Storage Temperature Range		T_{STG}	-55 ~ +175	°C

Notes: 1. Absolute maximum ratings are stress ratings only and functional device operation is not implied. Absolute maximum ratings are those values beyond which the device could be permanently damaged.
2. Pulse width limited by maximum junction temperature.

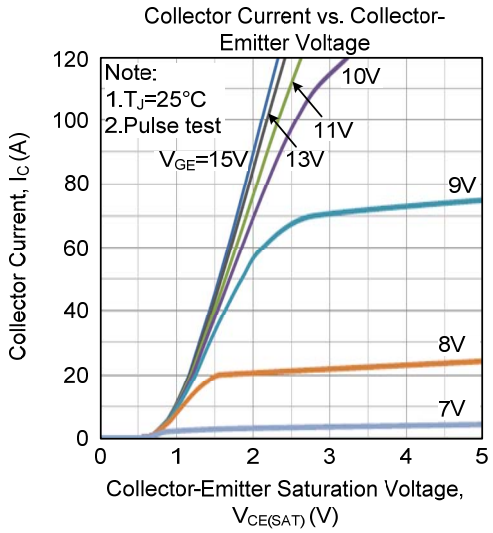
■ THERMAL DATA

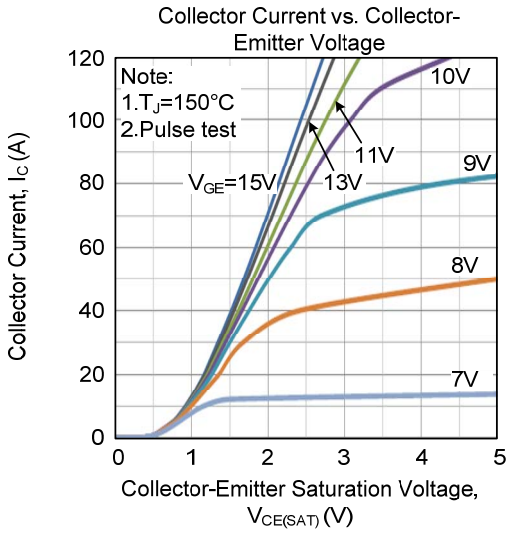
PARAMETER		SYMBOL	RATING	UNIT
Junction to Case	TO-220	θ_{JC}	1.0	°C/W
	TO-247		0.4	°C/W

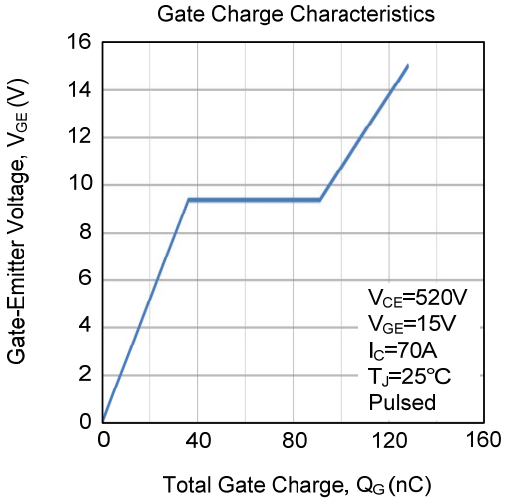
■ ELECTRICAL CHARACTERISTICS (T_C=25°C, unless otherwise noted)

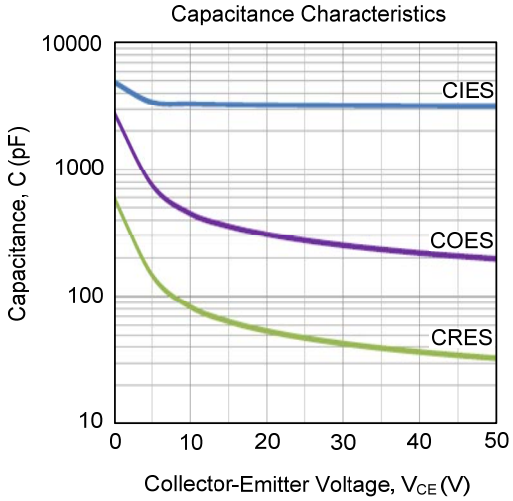
PARAMETER	SYMBOL	TEST CONDITIONS		MIN	TYP	MAX	UNIT
Off Characteristics							
Collector-Emitter Breakdown Voltage	BV_{CES}			650			V
Collector Cut-Off Current	I_{CES}	V_{CE}=650V, V_{GE}=0V				5	μA
G-E Leakage Current	I_{GES}	V_{CE}=0V, V_{GE}=±20V				±400	nA
On Characteristics							
Gate to Emitter Threshold Voltage	$V_{GE(TH)}$	I_C=250μA, V_{CE}=V_{GE}		4.5		6.5	V
Collector to Emitter Saturation Voltage	$V_{CE(SAT)}$	I_C=70A, V_{GE}=15V	T_C=25°C		1.75	2.1	V
			T_C=125°C		2.0		V
Dynamic Characteristics							
Input Capacitance	C_{IES}	V_{CE}=25V, V_{GE}=0V, f=1MHz			3220		pF
Output Capacitance	C_{OES}				272		pF
Reverse Transfer Capacitance	C_{RES}				44.6		pF
Switching Characteristics							
Total Gate Charge	Q_G	V_{CE}=520V, I_C=70A, V_{GE}=15V			125.7		nC
Gate-Emitter Charge	Q_{GE}				34		nC
Gate-Collector Charge	Q_{GC}				58.3		nC
Turn-On Delay Time	$t_{DON)}$	V_{CC}=400V, I_C=70A, R_G=5Ω, V_{GE}=0~15V, L=500uH			21		ns
Rise Time	t_R				75		ns
Turn-Off Delay Time	$t_{DOFF)}$				113		ns
Fall Time	t_F				55		ns
Turn-On Switching Loss	E_{ON}				2.97		mJ
Turn-Off Switching Loss	E_{OFF}				2.45		mJ
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Forward Voltage Drop	V_F	I_F=70A			1.5	3.0	V
Reverse Recovery Time	t_{rr}	I_F=70A, dI/dt=100A/μS, V_{CC}=400V			41.5		ns
Reverse Recovery Charge	Q_{rr}				201.3		nC

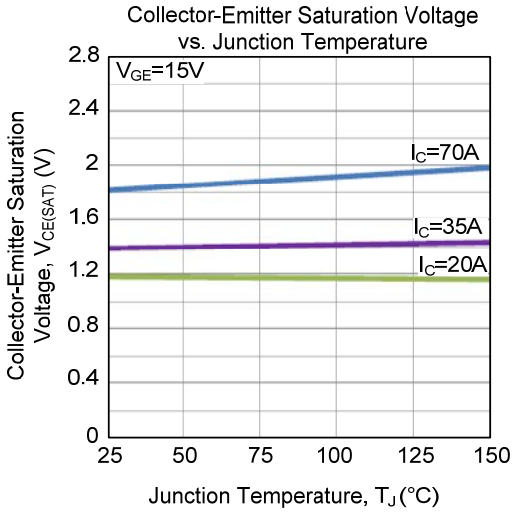
■ TYPICAL CHARACTERISTICS

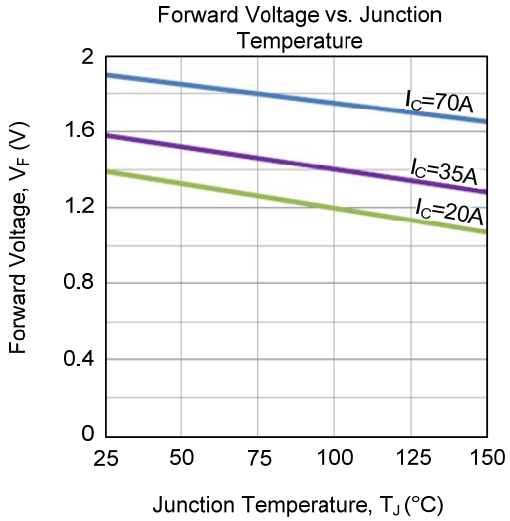






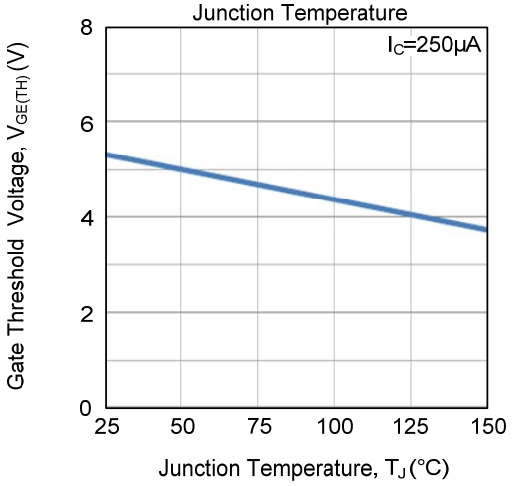




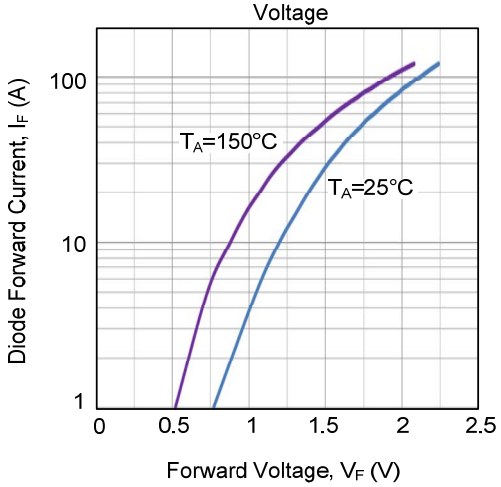


■ TYPICAL CHARACTERISTICS (Cont.)

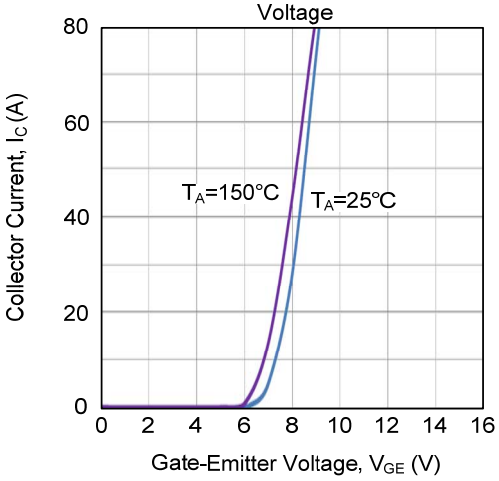
Gate Threshold Voltage vs. Junction Temperature



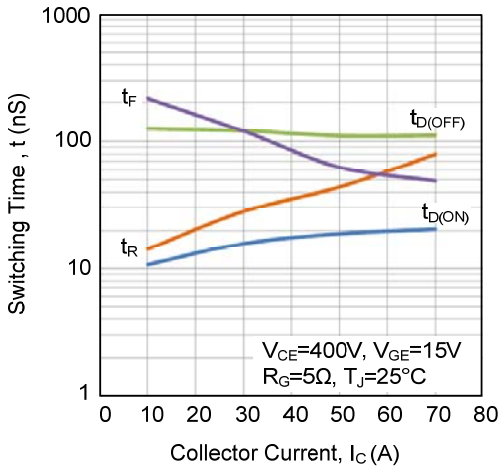
Diode Forward Current vs. Forward Voltage



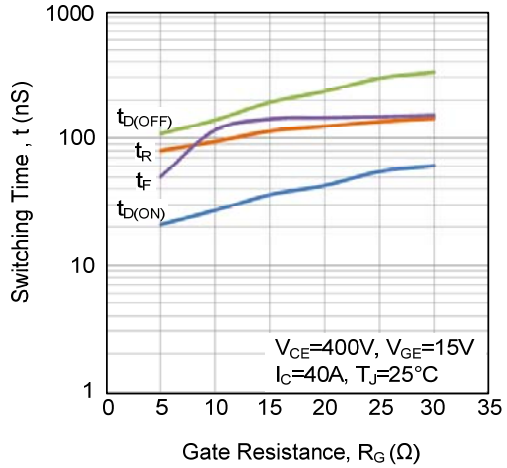
Collector Current vs. Gate-Emitter Voltage



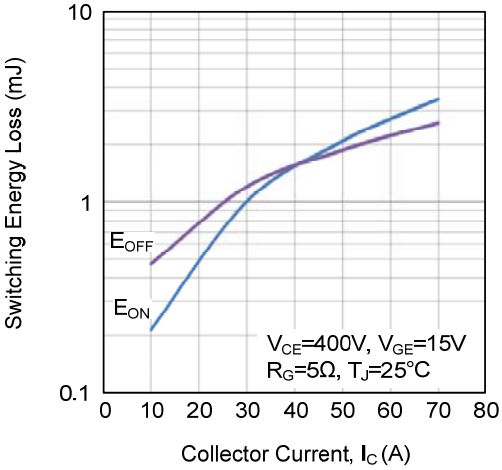
Switching Time vs. Collector Current



Switching Time vs. Gate Resistance

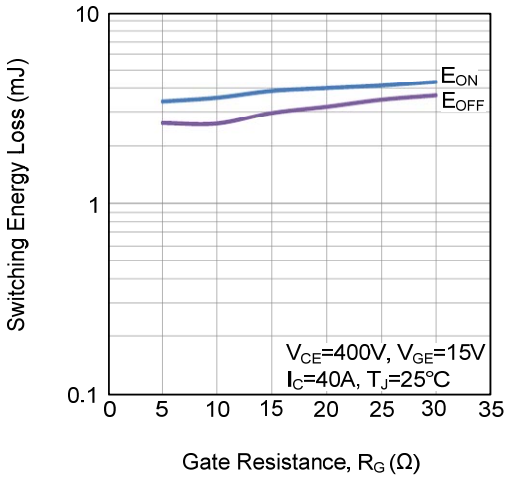


Switching Loss vs. Collector Current

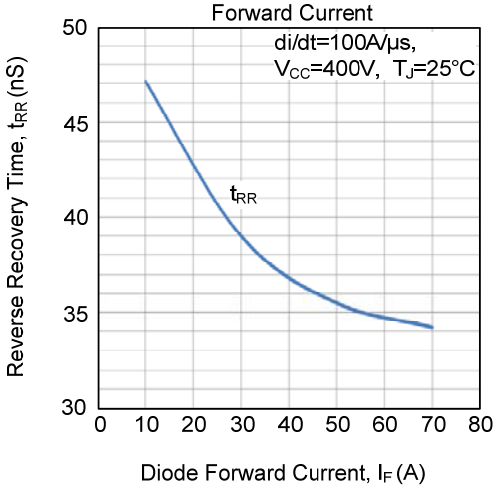


■ TYPICAL CHARACTERISTICS (Cont.)

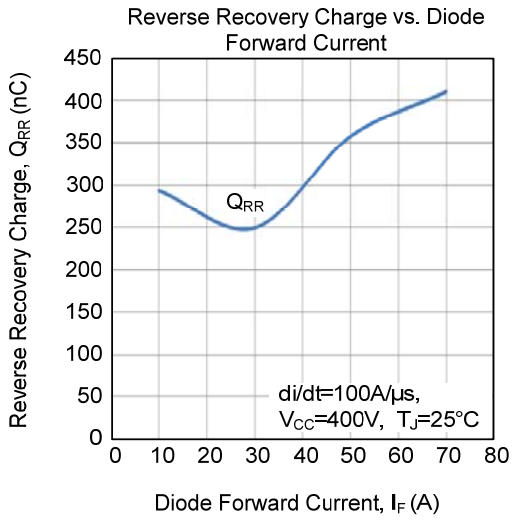
Switching Loss vs. Gate Resistance



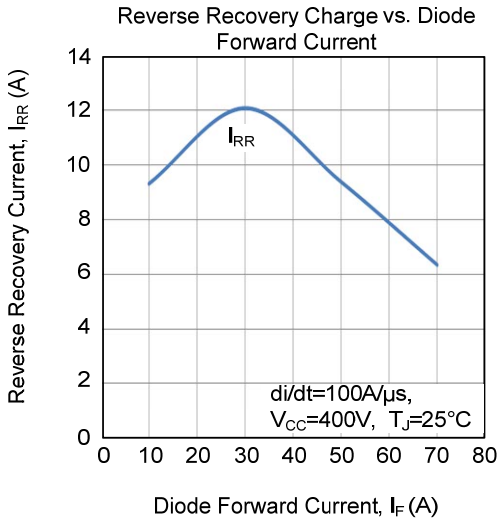
Reverse Recovery Time vs. Diode Forward Current



Reverse Recovery Charge vs. Diode Forward Current



Reverse Recovery Charge vs. Diode Forward Current



Safe Operating Area